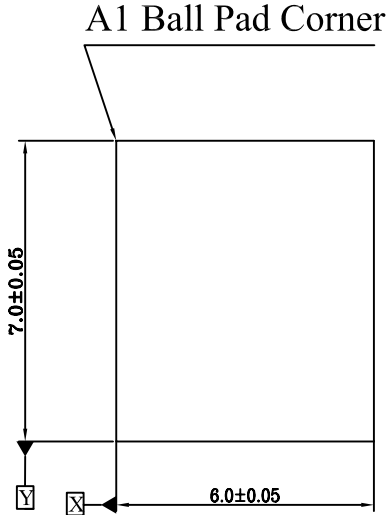
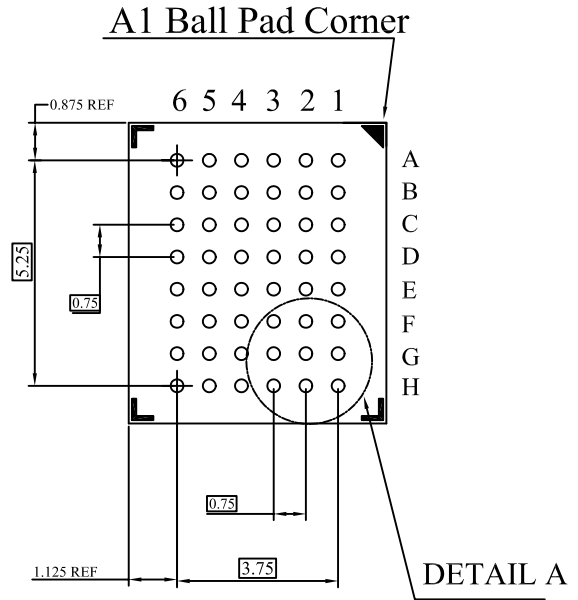


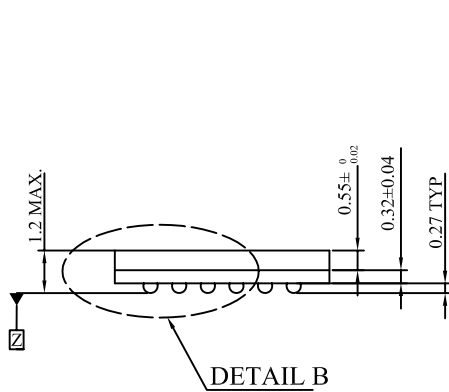
Title: Package outline for 48 ball Mini BGA-6x7mm



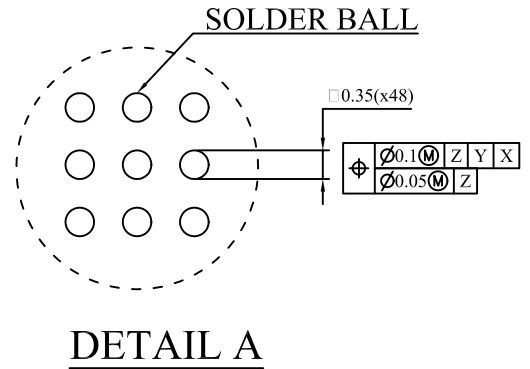
TOP VIEW (DIE VIEW)



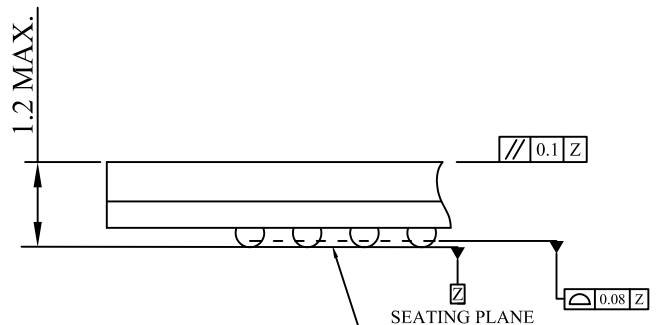
BOTTOM VIEW (BALL SIDE)



SIDE VIEW



DETAIL A



DETAIL B

NOTES:

1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS.
2. PIN#1 DOT MARKING BY LASER OR PAD PRINT.
3. SYMBOL "N" IS THE NUMBER OF SOLDER BALLS.

DWG. NO.	ORIGINATOR	ISSUE DATE	REV.
PC600-0020	Yuki_Yeh	06-Dec.-'04	0